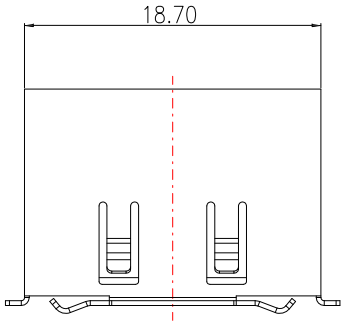
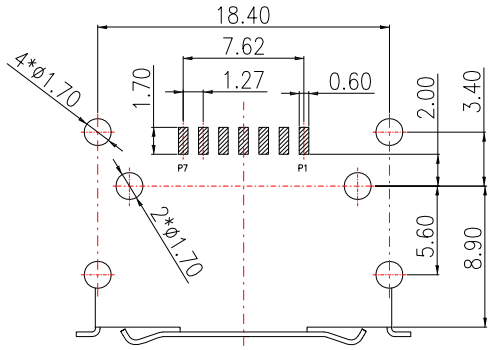
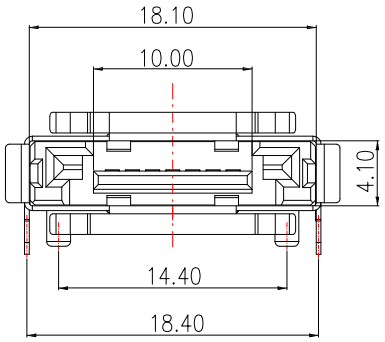
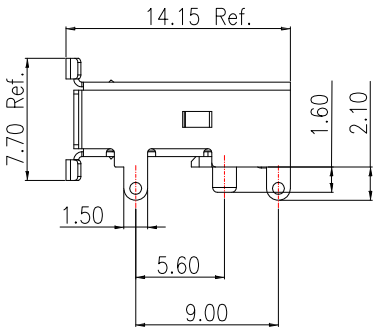
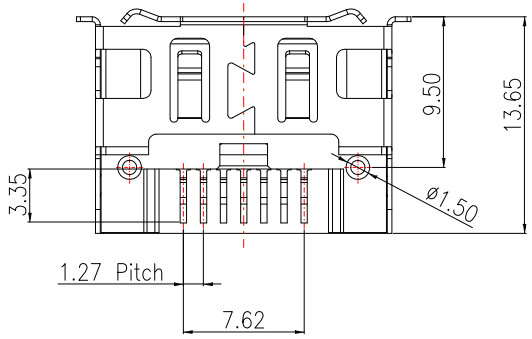




RECOMMENDED PCB LAYOUT







EST-M07-535S-x-S268

鍍層厚度 :

Blank : 1u"
2 : 15u"
3 : 30u"

SPECIFICATION:

1.MATERIAL:

HOUSING: LCP , UL 94V-0 , Black.

CONTACT: BRASS

SHELL: BRASS

2.Finish:

Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall

Shell: Nickel under Plated surface layer

ITEM NO.	DESCRIPTION	DRAWN	DATE

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED :
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

3RD. ANGEL'S | UNITS | MM

DRAWN BY: Jack Lu	DATE 11/18/13	MAT'L	
CHECKED BY: Jacky Chen	DATE 11/18/13	FINISH	
APPROVED BY: Tony Kao	DATE 11/18/13	SCALE 1 : 1	SHEET NO. 1 of 1

TITLE	CONNECTOR		
MODLE	ESATA 7P Male Front R/A DIP TYPE		
DWG NO.	EST-M07-535S-x-S268	SIZE	A4
PART NO.	EST-M07-535S-x-S268	VER	R